

MULTI-INNO TECHNOLOGY CO., LTD.

www.multi-inno.com

TOUCH PANEL SPECIFICATION

Model : MI0430CCP-C

For Customer's Acceptance:

Customer	
Approved	
Comment	

Revision	1.1
Engineering	
Date	2012-09-14
Our Reference	



REVISION RECORD

REV NO.	REV DATE	CONTENTS	REMARKS
1.0	2012-05-15	Initial Release	
1.1	2012-09-14	Updating the viewing area size of cover lens.	



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3. GENERAL SPECIFICATIONS

Item	Specification	Unit
Туре	Transparent type projected capacitive touch panel	
Input mode	Human's finger	
Substrate Thickness	0.55	mm
Outline Dimension	115.1(W) x 73.9(H)*1.4(D)	mm
Transparency	≧85	%
Haze	≦1.0	%

4. ELECTRICAL CHARACTERISTICS

4.1 Absolute Maximum Ratings

Parameter	Symbol		Unit		
Falameter	Symbol	Min.	Тур.	Max.	
Supply voltage	VCC	-0.3	-	7	V
Switch control signals output current	Output current	-	50	-	mA
Enable control voltage range	Logic Input	-0.3	-	VCC+0.3	V
Output Control Driver	Output voltage	-0.3	-	VCC	V
Operating temperature	Temperature OP	-20		60	°C
Storage temperature	Temperature ST	-30		70	°C

4.2 DC characteristics

Paramotor	Symbol		Unit		
Falameter	Symbol	Min.	Тур.	Max.	
Supply voltage	VCC	2.7	3.3	3.5	
Input high voltage	Vін	0.7 * VCC	-	VCC	V
Input low voltage	VIL	0	-	0.3 *VCC	V

5. PIN CONNECTIONS

No.	Name	I/O	Description
1	GND	-	Ground
2	GND	-	Ground
3	XRES	I	NC pin; please keep floating
4	XRES	I	NC pin; please keep floating
5	INT	0	Interrupt, Active low
6	INT	0	Interrupt, Active low
7	SCL	I	Serial Clock access
8	SCL	I	Serial Clock access
9	SDA	I/O	Serial data access
10	SDA	I/O	Serial data access
11	VCC	-	Power; VCC=+3.3V





Parameter	Symbol	Standa I ² C-	[.] d-Mode BUS	Fast-M I ² C-B	Unit	
		Min.	Max.	Min.	Max.	
SCL clock frequency	f _{SCL}	0	100	0	400	KHz
Bus free time between STOP and START condition	t _{BUF}	4.7	-	1.3	-	μs
Hold time (repeated) START condition.						
After this period, the first clock pulse is	t _{HD:STA}	4.0	-	0.6	-	μs
generated						
LOW period of the SCL clock	t _{LOW}	4.7	-	1.3	-	μs
HIGH period of the SCL clock	t _{HIGH}	4.0	-	0.6	-	μs
Set-up time for a repeated START condition	t _{su:sta}	4.7	-	0.6	-	μs
Data hold time	t _{HD:DAT}	0	-	0	0.9	μs
Data set-up time	t _{SU:DAT}	250	-	100	-	μs
Rise time of both SDA and SCL signals	t _R	-	1000	20+0.1C _b	300	μs
Fall time of both SDA and SCL signals	t _F	-	300	20+0.1C _b	300	μs
Set-up time for STOP condition	t _{SU:STO}	4.0	-	0.6	-	μs
Capacitive load for each bus line.	C _b	-	400	-	400	pF

Note:

(1) All values are referred to VIH (0.7xVCC) and VIL (0.3xVCC) level.

(2) A device must internally provide a hold time of at least 300ns for the SDA signal (referred to the VIH of the SCL signal) in order to bridge the undefined region of the falling edge of SCL.

(3) The maximum $t_{HD:DAT}$ has only to be met if the device does not stretch the LOW period (t_{LOW}) of the SCL signal.

- (4) A fast-mode l²C-bus device can be used in a standard-mode l²C-bus system, but the requirement $t_{SU:DAT} \ge 250$ ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCL signal. If such a device does stretch the LOW period of the SCL signal, it must output the next data bit to the SDA line $t_{R max}$ $t_{SU:DAT} = 1000+250=1250$ ns (according to the standard-mode l²C-bus specification) before the SCL line is released.
- (5) \dot{C}_b = total capacitance of one bus line in pF.

(6) If a spark or noise appear on SDA line and keep more than 25ns, Start or Stop condition will be identified if SCL

line keep high at this time.

7. Interface and Data Format

7.1 Transfer protocol (l²Cinterface)

MI0430CCP-C support I²C interface that need 2 hardware pin – serial data (SDA) and serial clock (SCL), carry information between the devices connected to the bus. The I²C bus supports serial, 8-bit oriented, bi-directional data transferred at a rate up to 100Kbit/s in the standard-mode, or up to 400Kbit/s in the fast-mode.

The data on the SDA line must be stable during the HIGH period of the clock. The HIGH or LOW state of the data line can only change when the clock signal on the SCL line is LOW.



Figure 7.1: I²C Signal timing

Within the procedure of the I²C -bus, unique situations arise which are defined as START and STOP conditions. A HIGH to LOW transition on the SDA line while SCL is HIGH is one such unique case. This situation indicates a START condition. A LOW to HIGH transition on the SDA line while SCL is HIGH defines a STOP condition. START and STOP conditions are always generated by the master. The I²C bus is considered to be busy after the START condition. The I²C bus is considered to be free again a certain time after the STOP condition.



Figure 7.2: I²C Start/Stop

7.2 I²C data transfer

The CTP MI0430CCP-C I²C address is 0x90H

Each byte has to be followed by an acknowledge bit. Data is transferred with the most significant bit (MSB) first. Every byte put on the SDA line must be 8-bits long. The number of bytes that can be transmitted per transfer is unrestricted. If controller can't receive or transmit another complete byte of data until it has performed some other function, for example servicing an internal interrupt, it can hold the clock line SCL LOW to force the master into await state. Data transfer then continues when the controller is ready for another byte of data and releases clock line SCL.





7.3 Format of data frame (I²C interface)

When master sends the command which be received by TP controller, the controller will responses the code and data. The format of communication is shown as Figure 7.4. The Command table that is written by master is defined on Command Table, Controller will response the response code first and data later.

Write mode





8. Command

8.1 Command list

Hex	Operation Code	D7	D6	D5	D4	D3	D2	D1	D0	Function
0	No operation	0	0	0	0	0	0	0	0	-
80	Sleep IN	1	0	0	0	0	0	0	0	-
81	Sleep Out	1	0	0	0	0	0	0	1	-
82	Sense Off	1	0	0	0	0	0	1	0	-
83	Sense On	1	0	0	0	0	0	1	1	-
	Read Event	1	0	0	0	0	1	0	1	-
	1st parameter	B31	B30	B29	B28	B27	B26	B25	B24	-
85	2nd parameter	B23	B22	B21	B20	B19	B18	B17	B16	-
	3rd parameter	B15	B14	B13	B12	B11	B10	B9	B8	-
	4th parameter	B7	B6	B5	B4	B3	B2	B1	B0	-
	Read All Events	1	0	0	0	0	1	1	0	-
	1st parameter	B31	B30	B29	B28	B27	B26	B25	B24	-
	2nd parameter	B23	B22	B21	B20	B19	B18	B17	B16	-
	3rd parameter	B15	B14	B13	B12	B11	B10	B9	B8	-
86	4th parameter	B7	B6	B5	B4	B3	B2	B1	B0	-
	5th parameter	E3	E2	E1	E0	FI	P2	P1	P0	-
	6th parameter	B23	B22	B21	B20	B19	B18	B17	B16	-
		:	:		:	:	:	:	:	-
	(n+1)th parameter	B7	B6	B5	B4	B3	B2	B1	B0	-
	Read Latest Event	1	0	0	0	0	1	1	1	-
	1st parameter	B31	B30	B29	B28	B27	B26	B25	B24	-
87	2nd parameter	B23	B22	B21	B20	B19	B18	B17	B16	-
	3rd parameter	B15	B14	B13	B12	B11	B10	B9	B8	-
	4th parameter	B7	B6	B5	B4	B3	B2	B1	B0	-
88	Clear Stack	1	0	0	0	1	0	0	0	-
9E	TS Software Reset	1	0	0	1	1	1	1	0	-

8.2 User define command list table

Hex	Operation Code	D7	D6	D5	D4	D3	D2	D1	D0	Function		
31h	Device ID	0 0 1 1 0 0 1 1										
	1st parameter		85									
	2nd parameter		20									
	3nd parameter	00										
32h	Version ID	0	0	1	1	0	0	0	1	Read Firmware version		



9. Command description

9.1 NOP

00 H	NOP (N	NOP (No Operation)									
	DNC	D7	D6	D5	D4	D3	D2	D1	D0	HEX	
Command	0	0	0	0	0	0	0	0	0	00	
Parameter	No para	ameter									
Description	This co touch s	This command is an empty command and it does not have any effect on the touch screen.									
Restriction											
Register			Status			Availability					
Availability		TS Sleep Out					Yes				
		TS Sleep In					Yes				
	Status					Default Value					
Default		Powe	r Up Seq	uence		N/A					
Derduit		TS S/W Reset					N/A				
		H/W Reset					N/A				
Flow Chart											



9.2 TS sleep in (80h)

80H	TSSLPIN (Touch Screen Sleep In)									
0011	DNC	D7	D6	D5	D4	D3	D2	D1	D0	HEX
Command	0	1	0	0	0	0	0	0	0	80
parameter					No par	ameter			•	
Description	This co mode. MCU in	mmand c terface a	auses th	e touch s er are still	creen to working	enter the	minimun	n power (ontents	consumpt	ion
Restriction	This co TS Slee It will be for the s It will be Sleep I	mmand h ep In Mode a necessa supply vo e necessa n Mode) h	as no eff le can or ary to wa ltages ar ary to wa pefore TS	Fect when ily be left it 5msec nd clock c it 5msec S Sleep Ir	the touc by the T before se ircuits to after sen comma	th screen S Sleep (ending ne stabilize ding TS S nd can be	is alread Out Comr ext comm Sleep Ou e sent.	y in TS S mand (81 and. This t comma	Bleep In m h). s is to allo nd (when	iode. w time in TS
Register Availability			Status				A	vailability		
		TS	S Sleep	Out				Yes		
		Т	S Sleep	In				Yes		
			Status				Def	fault Valu	е	
Default		Powe	r Up Sec	luence			TS SI	eep In M	ode	
		TS	SS/WRe	eset			TS SI	eep In M	ode	
		ł	H/W Res	et	_		TS SI	eep In M	ode	
Flow Chart		<		Stop DC/DC converter Stop Internal Dscillator			Legend Comma Parame Touc Scree Action Mod Sequen transfer	and eter ch n e tial		



9.3 TS sleep out (81h)

81H	TSSLP	OUT (Tou	ch Scree	n Sleep C	out)						
	DNC	D7	D6	D5	D4	D3	D2	D1	D0	HEX	
		1	0	0	0	0	0	0	1	81	
Description	This co	mmand tu	rns off TS	S Sleen In	mode						
Description	This co	mmand ha	as no effe	ct when t	ouch scre	en is alre	adv in TS	Sleep Or	ut mode.]	rs	
Restriction	Sleep C It will be the sup The tou during t function when th It will be Sleep C	Out Mode e necessa ply voltag ch screen his 5msec ality if fac e touch s e necessa Out mode)	can only I ry to wait es and clo loads all c and ther tory defau creen is a ry to wait before T	be left by 5msec be ock circuit touch sor e cannot ult and rea already TS 5msec af S Sleep C	the TS SI efore send s to stabi een supp be any at gister valu S Sleep O ter sendir Out comm	eep In Co ding next lize. olier's facto onormal e ues are sa out – mode ng TS Sle and can b	mmand (command ory defaul ffect on th me when e. ep In com be sent.	80h). I. This is t It values to the touch s this load	o allow tir o the regis creen is done a nen in TS	ne for sters nd	
Desister			Status				A	vailability			
Availability		Т	S Sleep (Out				Yes			
		-	TS Sleep	In				Yes			
			Status				De	fault Valu	e		
Default		Powe	er Up Sec	quence		TS Sleep In Mode					
		T	S S/W Re	eset		TS Sleep In Mode					
			H/W Res	et			TS S	leep In M	ode		
Flow Chart	<		TSSLP TSSLP Star Intern Oscilla V Start DC/D conver	t al ator DC rter				Command Parameter Touch Screen Action Mode			



9.4 TS sense off (82h)

82H	TSSOFF (Touch Screen Sense Off)										
0211	DNC	D7	D6	D5	D4	D3	D2	D1	D0	HEX	
Command	0	1	0	0	0	0	0	1	0	82	
parameter	No para	meter				NI					
Description	scannin	cn screei g.	n is not s	ensing to	ucnes (=						
Restriction	ļ										
Pogistor			Status			Availability					
Availability		Т	S Sleep	Out		Yes					
			TS Sleep	In				Yes			
			Status				De	fault Valu	е		
Default		Pow	er Up Sec	quence			TS	Sense O	ff		
		Т	S S/W Re	eset			TS	Sense O	ff		
			H/W Res	et			TS	Sense O	ff		
Flow Chart			TSSO TS Sense	FF				gend Command Paramete Touch Screen Action Mode equential ansfer			



9.5 TS sense on (83h)

83H	TSSON (Touch Screen Sense On)											
	DNC	D7	D6	D5	D4	D3	D2	D1	D0	HEX		
Command	0	1	0	0	0	0	0	1	1	83		
parameter	No para	imeter			- (- Nia ma		`					
Description	The tou	ch screen	i is sensir	ig touches	s (= NO RE	events).					
Restriction			<u> </u>									
Register			Status	2		Availability						
Availability		T	S Sleep (Jut				Yes				
			TS Sleep	In				Yes				
			Status			Default Value						
Default		Powe	er Up Sec	luence		TS Sense Off						
		T	S S/W Re	eset		TS Sense Off						
			H/W Res	et			TS	Sense O	ff			
Flow Chart			TSSON	ı In				Command Paramete Touch Screen Action Mode equential ansfer				



	0511	ROE (Read One Event)											
	85H	DNC	DNC D7 D6 D5 D4 D3 D2 D1 D0 HEX										
Co	ommand	0	1	0	0	0	0	1	0	1	85		
1	parameter	-	B31	B30	B29	B28	B27	B26	B25	B24	ХХ		
2	parameter	-	B23	B22	B21	B20	B19	B18	B17	B16	ХХ		
3	parameter	-	B15	B14	B13	B12	B11	B10	B9	B8	xx		
4	parameter	-	B7	B6	B5	B4	B3	B2	B1	B0	XX		
	parameter escription	- This co counter empty a A return co-ordir Touch \ Block is Point IE Points r	B7 mmand r (dc) value after this of nates and Width: Re 5 150 (96i 0: Report number: F	B6 eturns or les inform command e can be d related f eport the h). If it ha the ID of Report th Report th	B5 ne touch nation ha d. "No Ever touch info touched is three to touched e touch r touched c touch r	B4 event wh is been s nt" if the s ormation: block. Fo ouched b points. number. Point3 Point3 Point1 Y40ow Y40figh X40figh	B3 at is the o tored on stock is e or example block, the Area Area Area Area Area byte byte	B2 oldest co the stock mpty. e: if RX= report va	B1 -ordinate The events 15, TX=1 alue is 03	B0 s or raw ent stack 0, the tot h. Don't Can Don't Can Point ID Point num	xx is cal		
		When c touched been to	24 bytes X3(Low byte) X3(Low byte) X3(Low byte) Y2(Low byte) X2(Low										

9.6 Read One Event (85h)









	5.7 Read All Events)										
	86H	DNC	D7	D6	D5	D4	D3	D2	D1	D0	HEX
Сс	ommand	0	1	0	0	0	0	1	1	0	86
1	parameter	-	B31	B30	B29	B28	B27	B26	B25	B24	хх
2	parameter	-	B23	B22	B21	B20	B19	B18	B17	B16	xx
3	parameter	-	B15	B14	B13	B12	B11	B10	B9	B8	xx
4	parameter	-	B7	B6	B5	B4	B3	B2	B1	B0	xx
5	parameter	-	E3	E2	E1	E0	F1	P2	P1	P0	xx
6	parameter	_	B23	B22	B21	B20	B19	B18	B17	B16	хх
	:	-	:	:	:	:	:	:	:	:	:
(n	+1) Parameter	-	B7	B6	B5	B4	B3	B2	B1	B0	XX
De	escription	counter be "No co-ordir Touch V Block is Point IE Points r 24 by When c touched	- B7 B0 B3 B4 B3 B2 B1 B0 xx This command returns one touch event what is the oldest co-ordinates or raw counter (dc) values information has been stored on the stock. A returning value can be "No Event" if the stock is empty. co-ordinates and related touch information: Touch Width: Report the touched block. For example: if RX=15, TX=10, the total Block is 150 (96h). If it has three touched block, the report value is 03h. Point ID: Report the ID of touched points. Points number: Report the touch number. Value byde Value byde Val								
Av	ailability			Status				A	vailability		

9.7 Read All Event (86h)







	0.0 Read Edite											
	87H		NC D7 D6 D5 D4 D3 D2 D1 D0 HEX									
Co	mmand		1	0	0	04	0	1		1	87	
1	parameter	-	B31	B30	B29	B28	B27	B26	B25	B24	xx	
2	parameter	-	B23	B22	B21	B20	B19	B18	B17	B16	XX	
3	parameter	-	B15	B14	B13	B12	B11	B10	B9	B8	ХХ	
4	parameter	-	B7	B6	B5	B4	B3	B2	B1	B0	ХХ	
4 De	parameter escription	- This co counter empty a A returr co-ordir Touch V Block is Point IE Points r	B7 mmand r (dc) value after this of nates and Width: Re 5 150 (96 D: Report number: F	B6 eturns or les inform command e can be d related f eport the h). If it ha the ID of Report th Report th Read using C	B5 ne touch of nation ha d. "No Ever touch info touched is three to touched e touch r data by CMD 0x87	B4 event whi is been s ormation: block. Fo ouched b points. number. Point3A Point3A Point1A Y4(Low b Y40High b 34(Low b	B3 at is the o tored on stock is en rea irea lock, the	B2 oldest co- the stock mpty. e: if RX= report va	B1 -ordinate The even 15, TX=1 alue is 03	B0 s or raw ent stack 0, the tol h. Don't Care Don't Care Point ID- Point number	is al	
		24 by When c touched been to	ne or mo d will be fi	pre points ill invalid not.	: (but not data 0xF	X4(High b Y3(Low b Y3(High b X3(Low b Y2(Low b Y2(Low b Y2(Low b X2(High b X2(Low b Y1(Low b X1(High b X1(Low b X1(High b) X1(Low b X1(High b)	yte) yte) yte) yte) yte) yte) yte) yte) yte) yte) yte) yte) to been tou et baseba	Read da CMD 0 uched, ot nd disting	ata by usi 1x85, 0x86 her pointa guish whi	ng s without ich point	has	

9.8 Read Latest Event (87h)







9.9 Clear Event Stack (88h)

884	CLRES (Clear Event Stack)											
0011	DNC	D7	D6	D5	D4	D3	D2	D1	D0	HEX		
Command	0	1	0	0	0	1	0	0	0	88		
parameter	No para	ameter										
Description	This co	mmand o	clears eve	ent stack	when the	e only ret	urn even	t can be "	No Even	t".		
Restriction												
Pogistor			Status			Availability						
Availability		T	S Sleep	Out		Yes						
			rS Sleep	In				Yes				
			Status				Det	fault Valu	е			
Default		Powe	er Up Sec	quence			En	npty Stac	k			
		Т	S S/W Re	eset			En	npty Stac	k			
			H/W Res	et			En	npty Stac	<u>k</u>			
Flow Chart		Cie	CLRE	S			Leg Ca Provide Carlos	end ommand arameter Touch Screen Action Mode quential nsfer				



9.10 TS Software Reset (9Eh)

9F H	TSSWRESET (Touch Screen Software Reset)								
VE 11	DNC D7	D6	D5	D4	D3	D2	D1	D0	HEX
Command		0	0	1	1	1	1	0	9E
parameter	No parameter		C = #+	Deseta			:		
Description	Vhen the Touc reset. It resets t (See default tab Note: The Mem	n Screen he comm oles in eac ory conte	Software ands and ch commands are u	Reset co l parame and desc naffectec	ommand ters to the ription.) I by this c	is written eir TS S/\ ommand	, it cause N Reset	s a softw default va	are alues.
Restriction	It will be necess reset. The touch scree registers during If Software Res 5msec before s Touch Screen S sequence.	en loads a this 5mso et is appli ending TS Software F	it 5msec all touch s ec. ed during S Sleep C Reset Co	before se screen su g TS Slee Dut comm mmand c	ending ne opplier's fa op Out mo nand. cannot be	ew comm actory de ode, it wil sent dur	and follov fault valu l be nece ing TS SI	wing software to the ssary to ware out	vare wait
		Status				A	vailability		
Register Availability	Т	S Sleep	Out				Yes		
		TS Sleep	In				Yes		
		Status				Def	ault Valu	е	
Default	Pow	er Up Seo	quence				N/A		
	Т	S S/W Re	eset				N/A		
		H/W Res	et				N/A		
Flow Chart	TS Set to De TS S	SSWRES Commar o TS S/M fault valu	SET Inds Jue Node				egend Comman Paramete Touch Screer Action Action Mode		



	21 🗆	Device	ID									
	ып	DNC	D7	D6	D5	D4	D3	D2	D1	D0	HEX	
Сс	ommand	0	0	0	1	1	0	0	0	1	31	
1	parameter	1	1 85 00.									
2	parameter	1				2	6				00FF	
3	parameter	1				0	0				00FF	
De	escription	When t index o	he Devic f Device	e ID con ID comn	nmand is nand is 3	s written, 81h	IC will e	cho the c	levice ID	to maste	er. The	
Re	egister vailability		T	Status S Sleep TS Sleep	s Out o In				Availabi Yes Yes	lity		
				Status	3			C	Default V	alue		
De	efault		Powe	er Up Se	quence				N/A			
			TS S/W Reset N/A									
]	H/W Re	set				N/A			
Fl	ow Chart											

9.11 Device ID Command (31h)

9.12 Version ID Command (32h)

32 🖬	Device ID											
52 11	DNC	D7	D6	D5	D4	D3	D2	D1	D0	HEX		
Command	0	0	0	1	1	0	0	1	0	31		
1 parameter	1		SF_Vers	sion[3:0]			F_Version[3:0]					
Description	This co F_Vers SF_Vei	his command will report the ID code of firmware Version. _Version [3:0]: The firmware version of flash code. F Version [3:0]: The firmware version of self test code.										
Register Availability	Status TS SI TS SIe	eep Out	;			Availa Yes Yes	bility					
	Status	s r Up Sea	uence			Defau N/A	lt Value					
Default	TS S/W Reset N/A H/W Reset N/A											
Flow Chart												



10. BLOCK DIAGRAM



Note : 1. USE APPROPRIATE RESISTOR VALUE DURING HIGH SPEED SCL CLOCK.

SUGGESTION : RESISTOR RECOMMENDATION : 1K ohm.

2. To reduce the noise from the power, we suggest you use the independent power for the touch panel (VCC)



11. QUALITY ASSURANCE 11.1 Test Condition

- 11.1.1 Temperature and Humidity (Ambient Temperature) Temperature: $25 \pm 5^{\circ}$ C Humidity: $65 \pm 5\%$
- 11.1.2 Operation Unless specified otherwise, test will be conducted under function state.
- 11.1.3 Container Unless specified otherwise, vibration test will be conducted to the product itself without putting it in a container.
- 11.1.4 Test Frequency

In case of related to deterioration such as shock test. It will be conducted only once.

	Poliphility Test Item & Loyal	Test Lovel
<u> </u>		
NO.	l est Item	
1.	High Temperature Storage Test	T= 70° C, 120hrs after 1 hrs at room temperature and test.
2.	Low Temperature Storage Test	T= -30 $^\circ\!\mathrm{C}$, 120hrs after 1 hrs at room temperature and test.
3.	High Temperature Operation Test	T= 60° C, 120hrs after 1 hrs at room temperature and test.
4.	Low Temperature Operation Test	T= -20 $^{\circ}$ C, 120hrs after 1 hrs at room temperature and test.
3.	High Temperature and High Humidity Storage Test	T= 40° C, 90%RH,120hrs after 24 hrs at room temperature and test.
4.	Thermal Cycling Test (No operation)	-30 $^\circ\!C$ 30min ~ 70 $^\circ\!C$ 30 min , 100 Cycles after 24 hrs at room temperature and test.
5.	Vibration Test (No operation)	Frequency :10 ~ 55 HZ Amplitude :1.5 mm Sweep time : 11 mins Test Period: 6 Cycles for each direction of X, Y, Z
6.	ESD TEST	Air Discharge : ±8KV Indirect Contact Discharge : ±4KV

11.1.5 Test Method



12. APPEARANCE SPECIFICATION

12.1Inspection and Environment conditions

- 12.1.1 Temperature: 25± 5℃
- 12.1.2 Humidity: 55 ± 10% RH
- 12.1.3 Light source: Fluorescent Light
- 12.1.4 Inspection: Viewing distance: 35±5cm
- 12.1.5 Ambient Illumination:
 - (1) Cosmetic Inspection: 500 ~ 800 lux
 - (2) Functional Inspection: 400 ~ 600 lux
- 12.1.6 Inspection View angle:
 - (1) Inspection under operating condition: ±5°
 - (2) Inspection under non-operating condition: ± 45°



12.2 Definition of applicable Zones



12.3 Judgment standard

The Judgment of the above test should be made after exposure in room temperature for two hours as follow:

- Pass: Normal display image with no obvious non-uniformity and no line defect. Partial transformation of the module parts should be ignored.
- Fail: No display image, obvious non-uniformity, or line defect.



Inspection Item	Inspection Criteria			Illustration
Foreign material (Black or White spots shape)	Zone Dimension D> 0.5 mm 0.3mm ≦D≦0.5mm D< 0.3mm	Acceptable number 0 5 *	Class of Defects Minor	D = (L + W) / 2
Foreign Material (Line shape)	Zone Dimension W> 0.1mm or L>10mr 0.05 mm≦W≦0.1 mr ≦10mm W< 0.05mm	Acceptab le number n 0 n L 5 *	Class of Defects Minor	L : Long W : Width
Dimension	Outline			(Major)
Scratch on the Touch panel	$\begin{tabular}{ c c } \hline Zone \\ \hline Dimension \\ \hline W > 0.1mm \ or \ L \\ > 10mm \\ \hline W \leqq 0.1 \ mm \ L \leqq \\ 10mm \\ \end{tabular}$	Acceptable number 0 5	Class of Defects Minor	
Dent on the Touch panel	$\begin{tabular}{c} Zone \\ \hline Dimension \\ \hline D> 0.5 \mbox{ mm} \\ \hline 0.3 \mbox{mm} \leq D \leq \ 0.5 \mbox{ mm} \\ \end{tabular}$	Acceptable number 0 n 5	e Class of Defects Minor	L D= (L + W) / 2
Corner Chipping	X<3 mm, Y<3 mm, Z< Glass thickness			x y z
Edge Chipping	X<3 mm, Y<3 mm, Z< Glass thickness			
Crack	reject			Y T

12.4 Cosmetic Specification and Inspection Items



13. PRECAUTIONS IN USE CTP

1. ASSEMBLY PRECAUTIONS

- Since Touch Panel is consist of glass, please be careful your hands to be injured during handing. You must wear gloves during handing.
- (2) Do not touch, push or rub the exposed touch panel, tweezers or anything harder than HB pencil lead. And please do not rub with dust clothes with chemical treatment.
- (3) Do not stack the touch panels together. Do not put heavy objects on touch panel.
- (4) Please do not take a CTP to pieces and reconstruct it. Resolving and reconstructing modules may cause them not to work well.
- (5) Please excessive force or strain to the panel or tail is prohibited, Do not lift touch panel by cable(FPC).
- (6) Use clean sacks or glove to prevent fingerprints and/or stains left on the panel. Extra attention and carefulness should be taken while handling the glass edge.
- (7) Please pay attention for the matters stated below at mounting design of touch panel enclosure. Enclosure support to fix touch panel must be out of active area.(do not design enclosure presses the active area to protect from miss put)

2. OPERATING PRECAUTIONS

- (1) Please be sure to turn off the power supply before connecting and disconnecting signal input cable.
- (2) Please do not change variable resistance settings in CTP. They are adjusted to the most suitable value. If they are changed, it might happen CTP does not satisfy the characteristics specification
- (3) Be careful for condensation at sudden temperature change. Condensation makes damage to sensor or electrical contacted parts.
- (4) CTP has high frequency circuits. Sufficient suppression to the electromagnetic interference 7. shall be done by system manufacturers. Grounding and shielding methods may be important to minimize the interference.
- (5) Touch the panel with your finger or stylus only to assure normal operation. Any sharp edged or hard objects are prohibited.
- (6) Operate the panel in a steady environment. Abrupt variation on temperature and humidity may cause malfunction of the panel.
- 3. ELECTROSTATIC DISCHARGE CONTROL
 - (1) The operator should be grounded whenever he/she comes into contact with the CTP. Never touch any of the conductive parts such the copper leads on the FPC and the interface terminals with any parts of the human body.

- (2) The CTP should be kept in antistatic bags or other containers resistant to static for storage.
- (3) Only properly grounded soldering irons should be used.
- (4) If an electric screwdriver is used, it should be well grounded and shielded from commentator sparks.
- (5) The normal static prevention measures should be observed for work clothes and working benches; for the latter conductive (rubber) mat is recommended
- (6) Since dry air is inductive to statics, a relative humidity of 50-60% is recommended.
- STORAGE PRECAUTIONS
- When you store touch panel for a long time, it is recommended to keep the temperature between 0°C-40°C without the exposure of sunlight and to keep the humidity less than 90%RH.
- (2) Please do not leave touch panel in the environment of high humidity and high temperature such as 60°C 90%RH
- (3) Please do not leave touch panel in the environment of low temperature; below -20°C.
- 6. OTHERS

For the packaging box, please pay attention to the followings:

- a. Please do not pile them up more than 5 boxes. (They are not designed so.) And please do not turn over.
- b. Please handle packaging box with care not to give them sudden shock and vibrations. And also please do not throw them up.
- c. Packing box and inner case for CTP are made of cardboard. So please pay attention not to get them wet. (Such like keeping them in high humidity or wet place can occur getting them wet.)
- LIMITED WARRANTY

Unless otherwise agreed between MULTI-INNO and customer, MULTI-INNO will replace or repair any of its CTP which is found to be defective electrically and visually when inspected in accordance with MULTI-INNO acceptance standards, for a period on one year from date of shipment. Confirmation of such date shall be based on freight documents. The warranty liability of MULTI-INNO is limited to repair and/or replacement on the terms set forth above. MULTI-INNO will not responsible for any subsequent or consequential events.



14. OUTLINE DRAWING

